

OpenNESS: Enabling High Performance Edge for Telco & Enterprise



Prakash Kartha



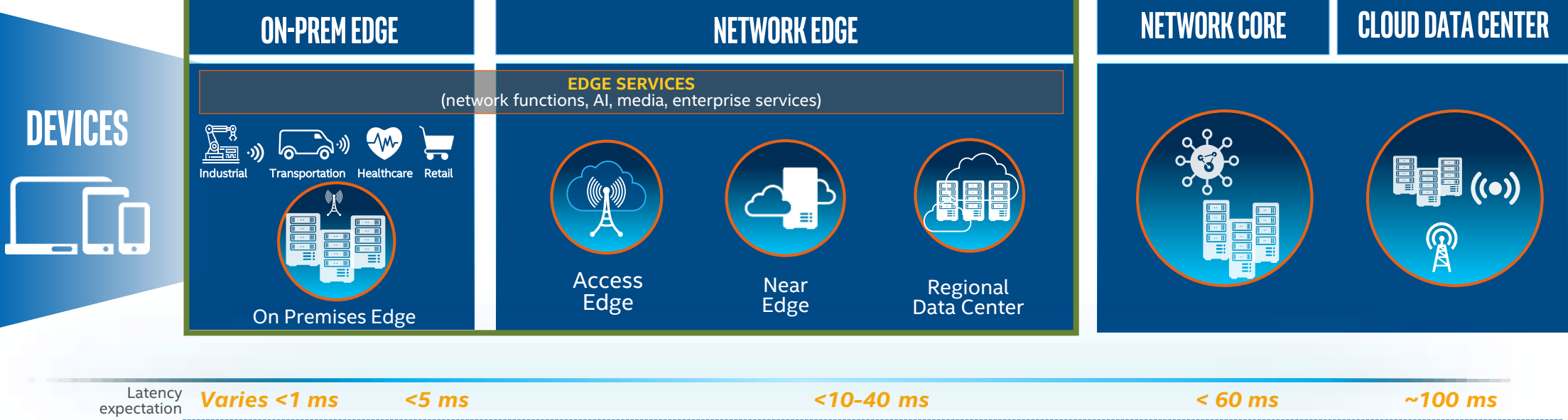
Amr Mokhtar



Agenda

- Opportunities/Challenges deploying Edge in a Telco environment
- Introduction to OpenNESS
- Architecture Overview
- Deployment Scenarios
- Getting Started
- Wrap up

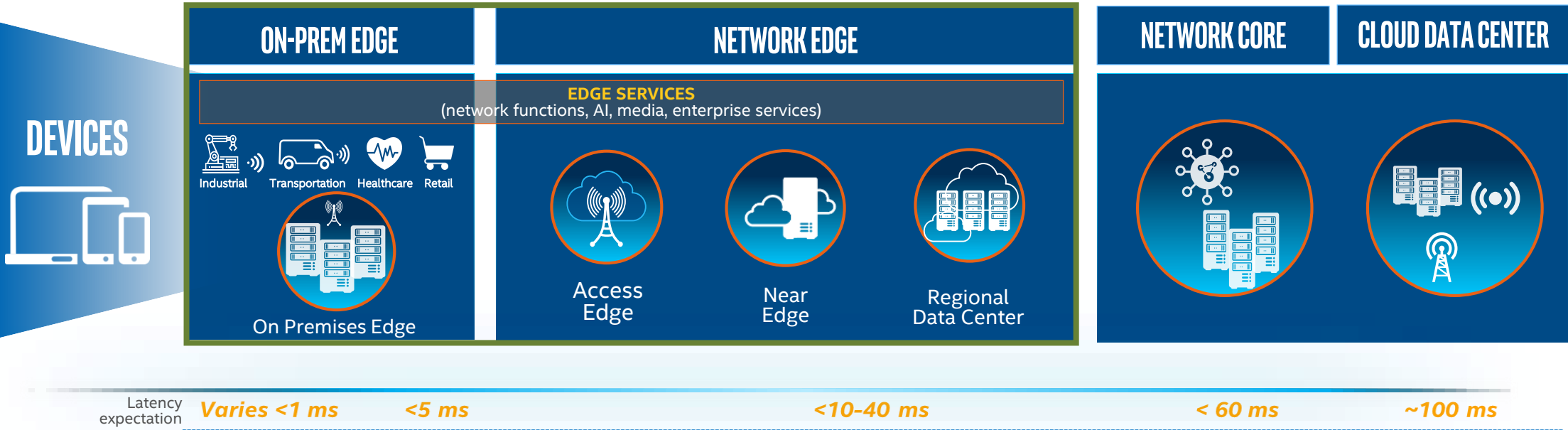
Delivering Cloud Native Platforms for the Edge



Market Opportunity: Lower TCO with a consistent cloud native platform approach across edge locations

SERVICES
MIDDLEWARE
RESOURCE and SERVICE ORCHESTRATION
OPERATING SYSTEM
EDGE HARDWARE PLATFORM

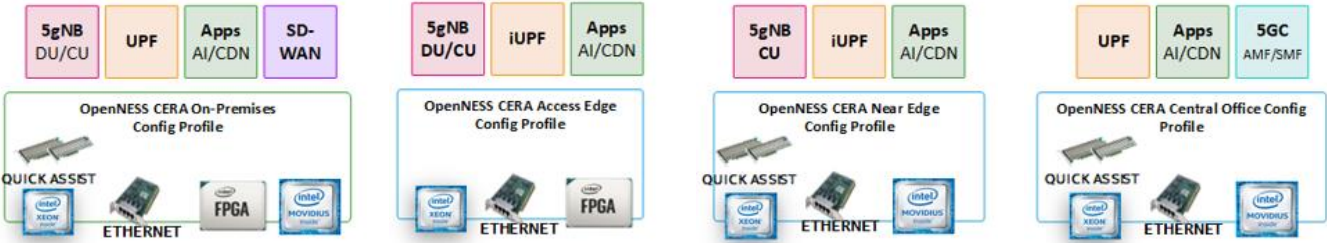
Delivering Cloud Native Platforms for the Edge



Market Opportunity: Lower TCO with a consistent cloud native platform approach across edge locations

Key challenges to overcome

- 1 Deliver platform consistency & scalability across diverse edge location requirements
- 2 Optimize cloud native frameworks to meet stringent edge KPIs and network complexity
- 3 Leverage a broad ecosystem and evolving standards for edge computing



Open Network Edge Services Software



OpenNESS is an edge computing software toolkit that enables **highly optimized, secure and performant edge platforms** to on-board and manage applications and network functions with **cloud-like agility across any type of network**



MODULAR



CONSUME AS BUILDING BLOCKS OR REFERENCE ARCHITECTURES



MICROSERVICES BASED ARCHITECTURE

Top Use Cases

- ✓ Access Edge Aggregation Point (Cloud Native RAN + Apps)
- ✓ Near Edge (5G dUPF + Apps)
- ✓ uCPE/SD-WAN + Apps
- ✓ AI/vision inferencing apps with MEC
- ✓ Media apps with MEC

OPENNESS BUILDING BLOCKS

Multi-access Networking	Edge Multi-Cluster Orch	Edge aware Serv mesh	Confidential Computing	Edge WAN Overlay
Resource Management	Data plane CNI	Telemetry & Monitoring	Apps and CNFs Acceleration	Green Edge

BUILT ON CLOUD NATIVE COMPUTING FOUNDATION

Kubernetes Service Mesh CNI Telemetry Helm Operator Fwk

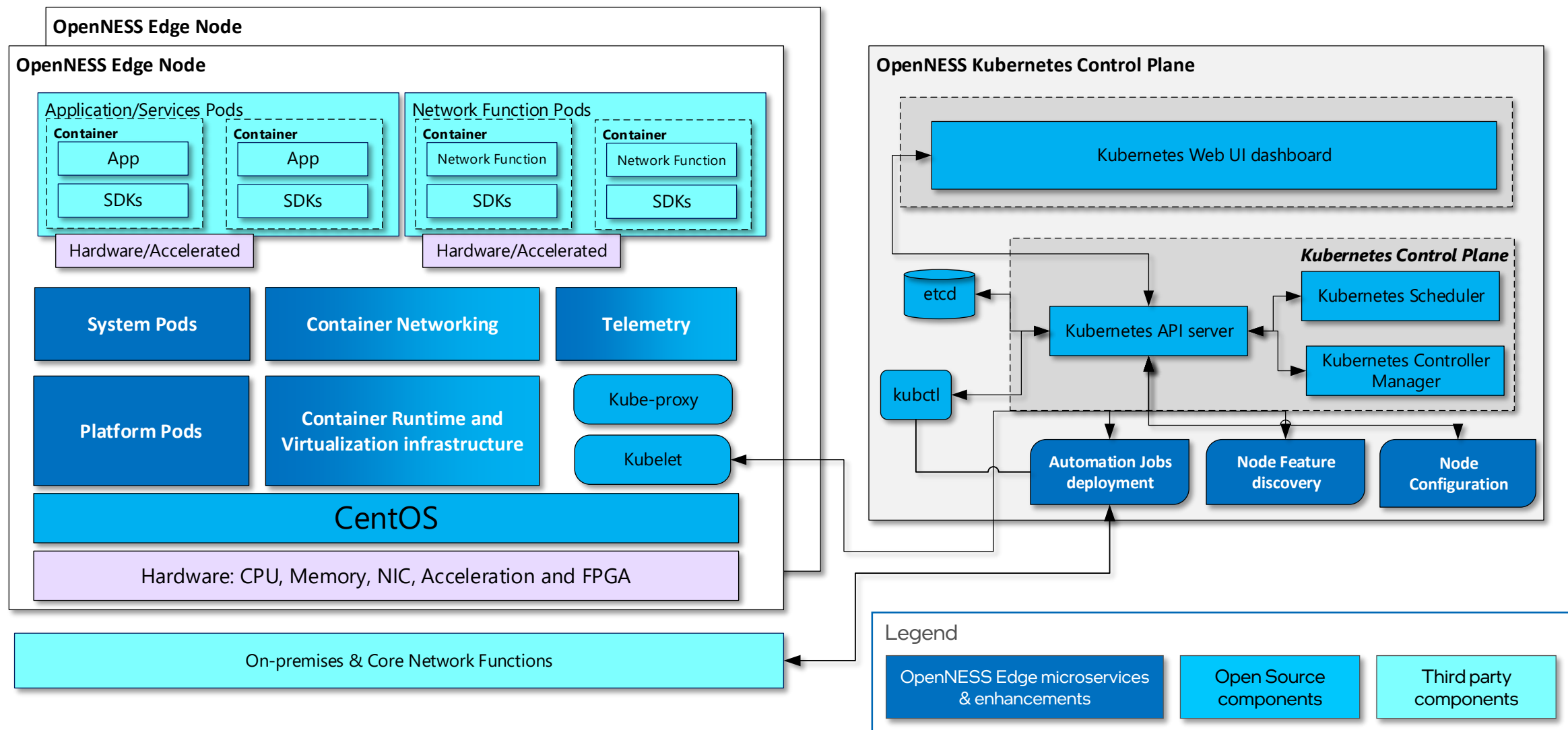
Key Features

- ✓ Optimized for Edge KPIs: throughput, determinism, QoS, latency, jitter, security
- ✓ Multi-location, Multi-Access, Multi-Cloud
- ✓ Delivered via use case specific Reference Architectures for easy of consumption and to accelerate TTM
- ✓ Industry Standards (3GPP, CNCF, ORAN, ETSI)

OpenNESS Architecture

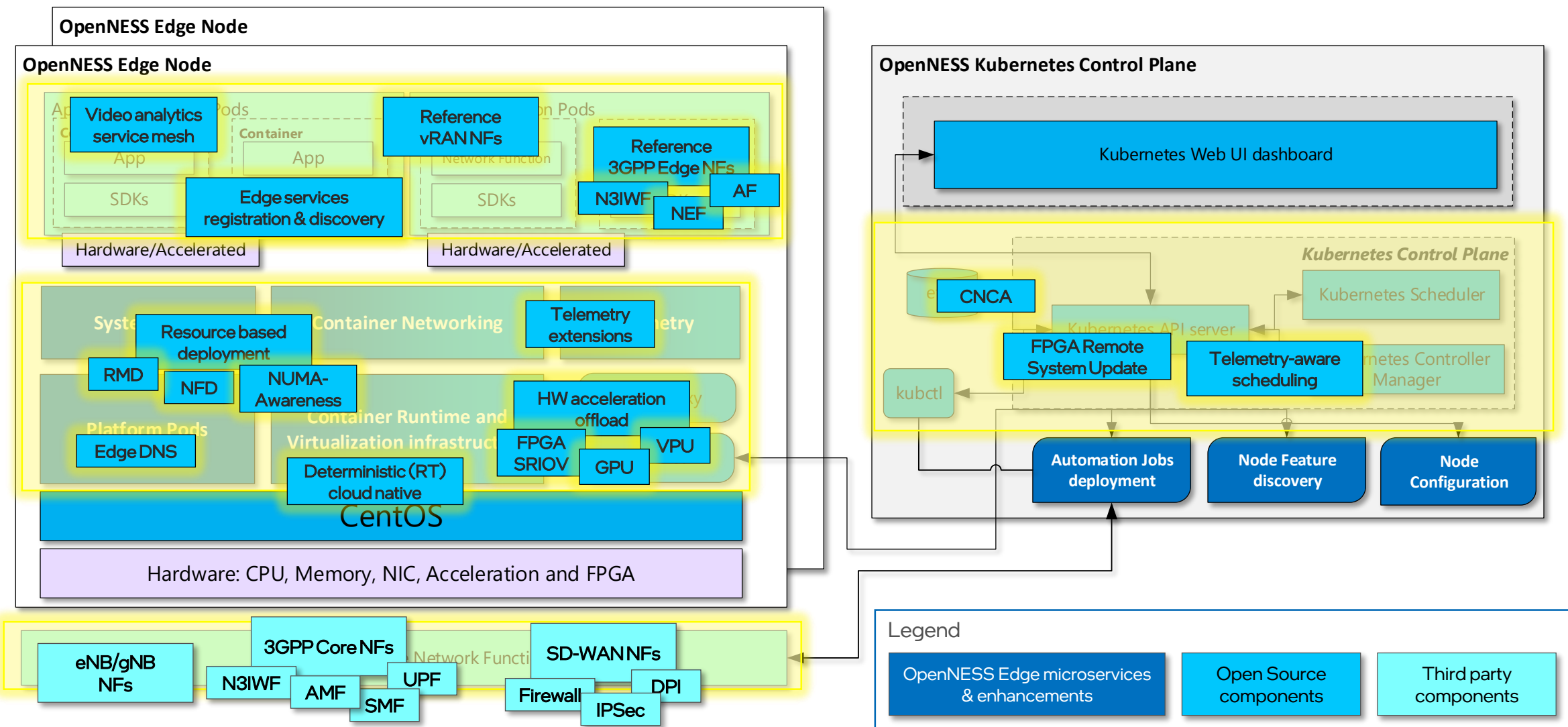


OpenNESS – Cloud Native Edge Computing Architecture



*OpenNESS Edge Node can be deployed on Network Edge or On-Premise Edge

Extending Kubernetes with Edge Capabilities



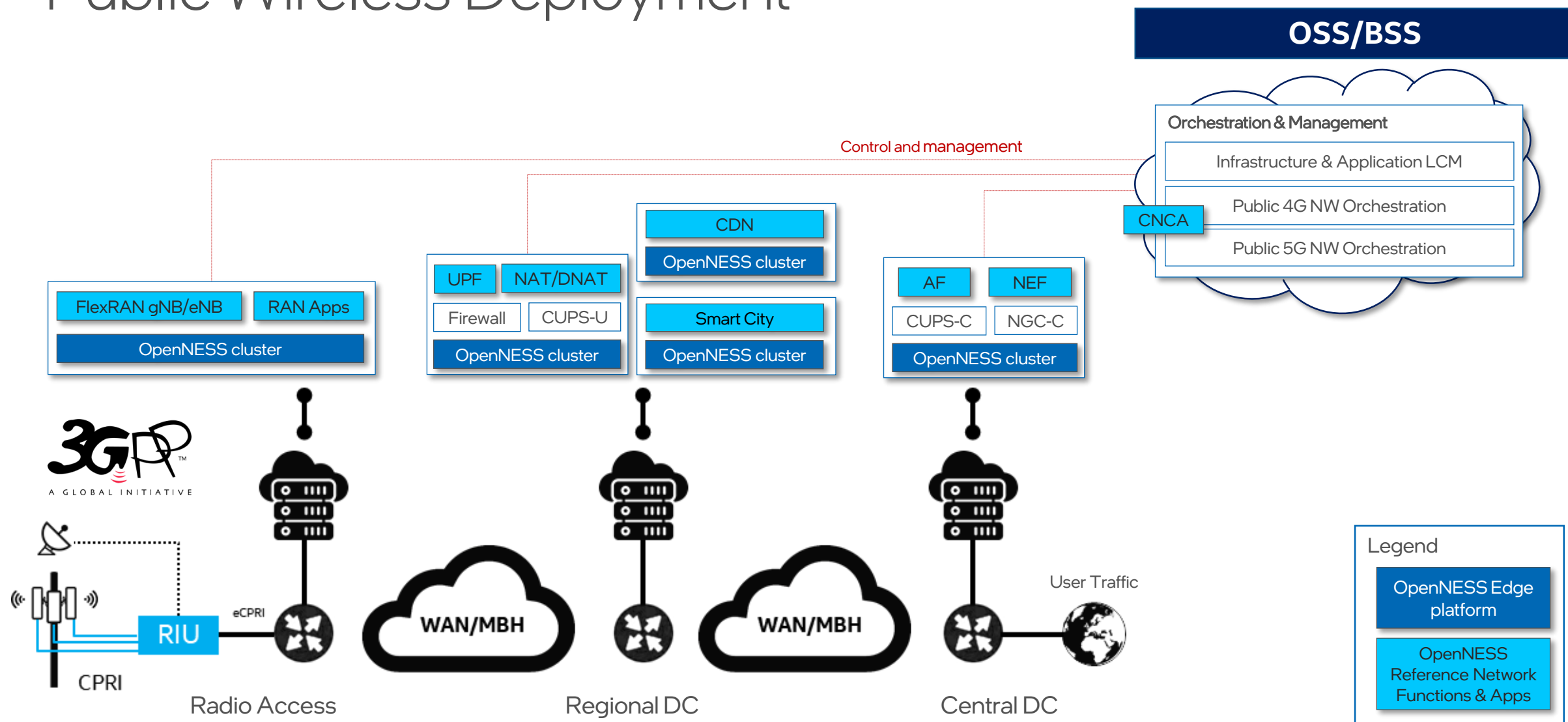
CNCA: Core Network Configuration Agent
NFs: Network Functions

RMD: Resource Management Daemon
VPU: Intel® Movidius™ Vision Processing Unit

Reference Deployment Scenarios with OpenNESS



Public Wireless Deployment

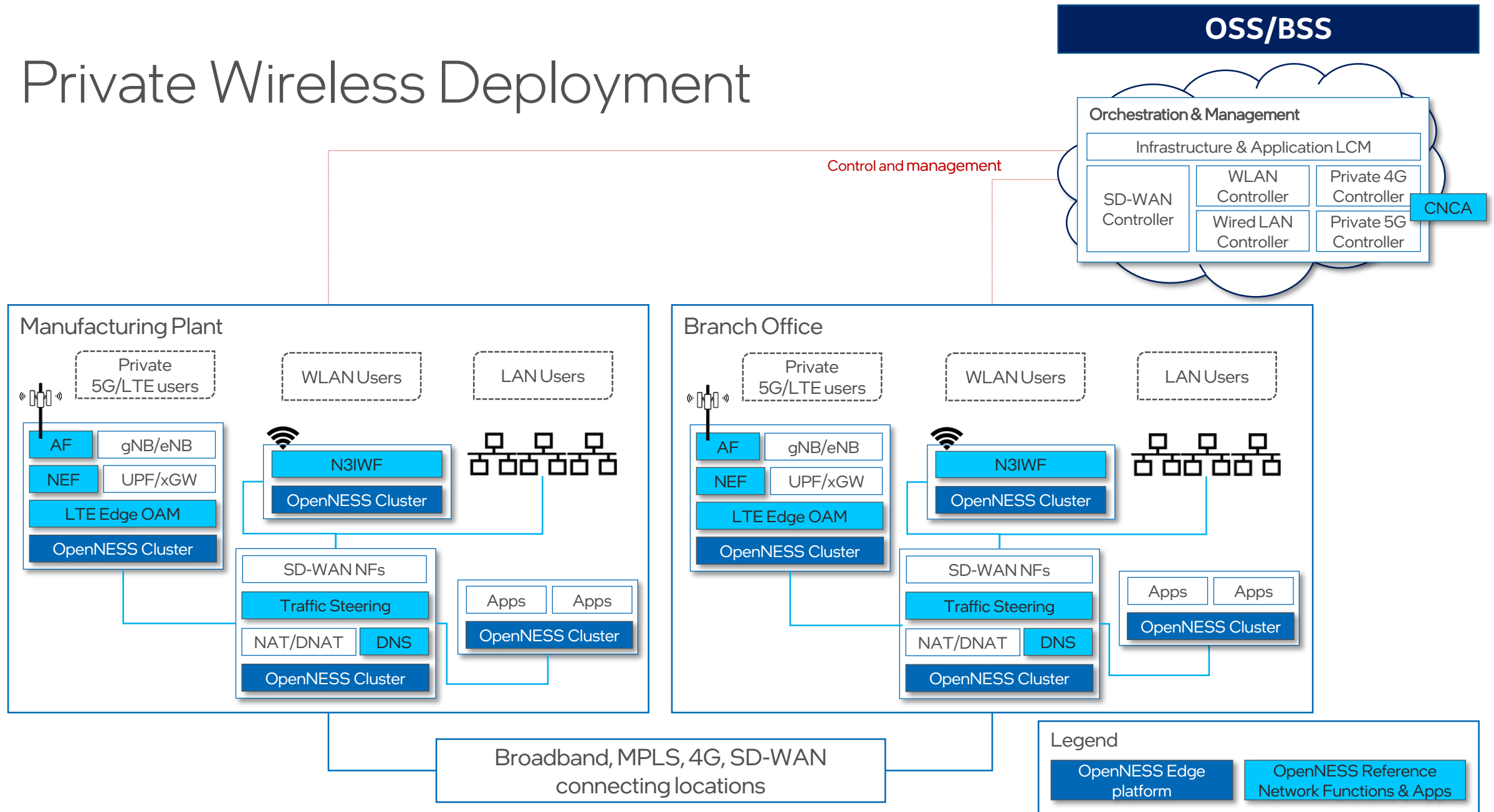


LCM: Life Cycle Management
CUPS: Control and User Plane Separation
RIU: Radio Interface Unit

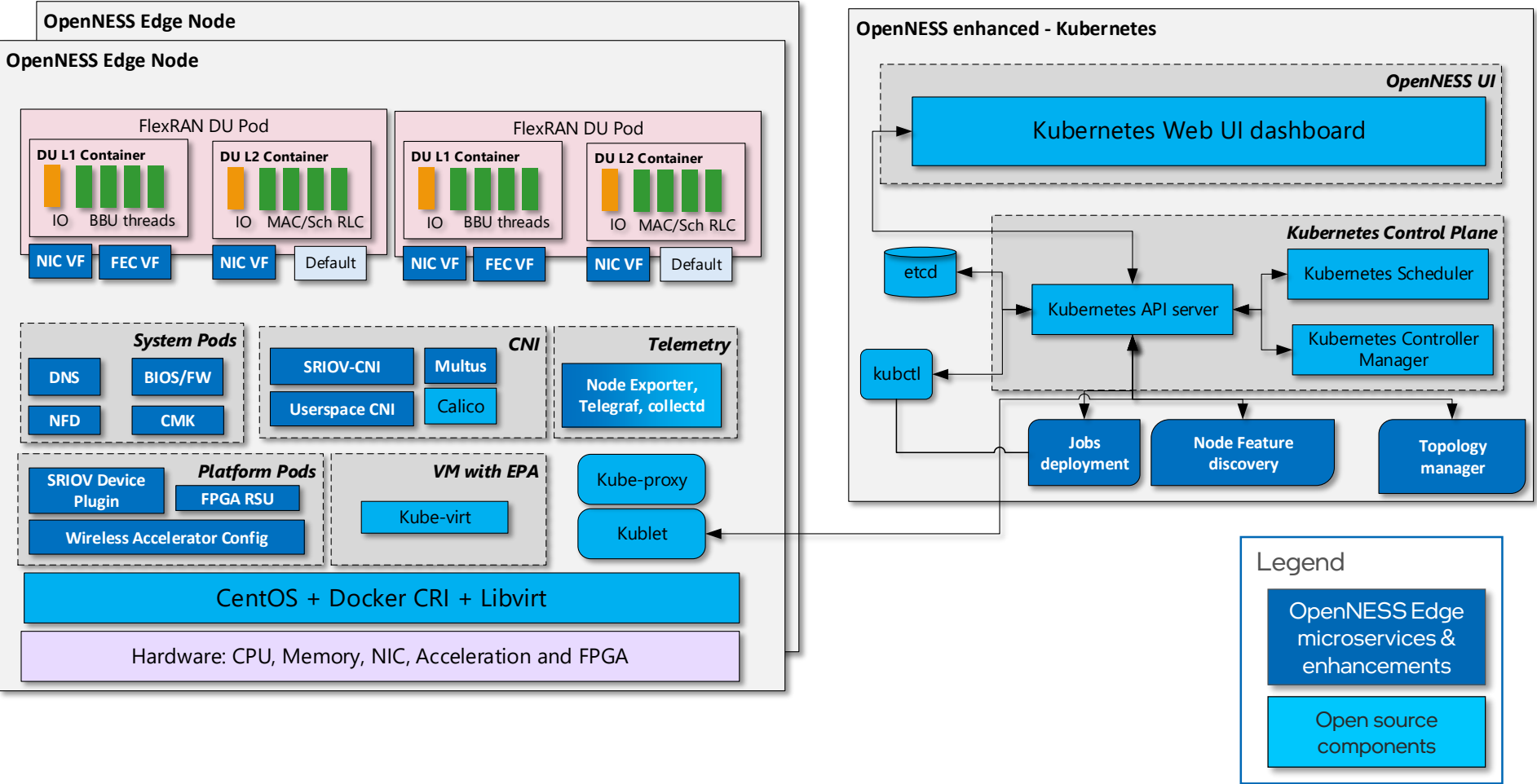
NGC: Next-Gen Core (5G)
CNCA: Core Network Configuration Agent
MBH: Microwave Backhaul

DC: Data Center

Private Wireless Deployment



Radio Access Edge (vRAN DU)



Deterministic IO

- DPDK
- NIC Offload (DDP)
- Kernel Driver
- Multiplex NW

Deterministic Acceleration

- FEC
- BBDev API (SW & HW Offload)
- FPGA & eASIC Support
- Arbitration, UL/DL Ratios

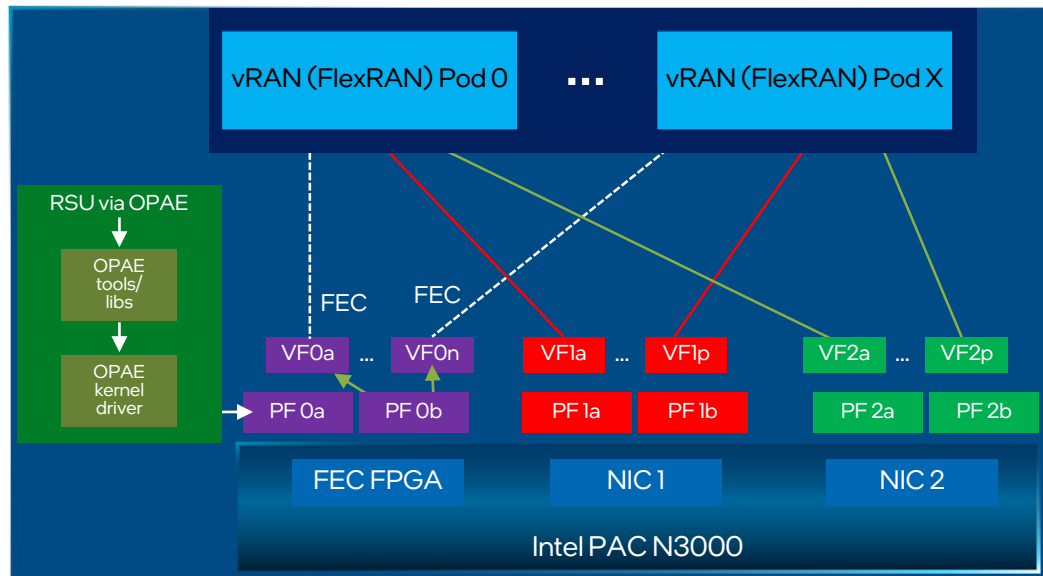
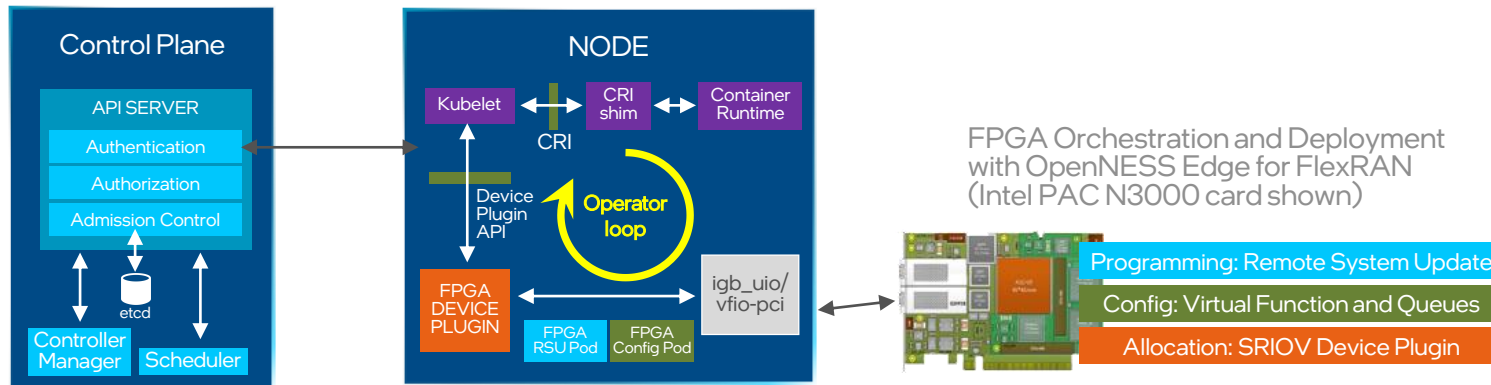
Deterministic Orchestration

- NUMA Awareness (Topology Manager)
- CMK & Native CPU Manager
- Node Feature Discovery

Deterministic Platform & Environment

- Real Time Kernel
- Complete Core Isolation
- Frequency & Power Management

Accelerators – Intel® FPGA PAC



OpenNESS Network Edge
Intel PAC N3000 RSU and
resource allocation

What does it do?



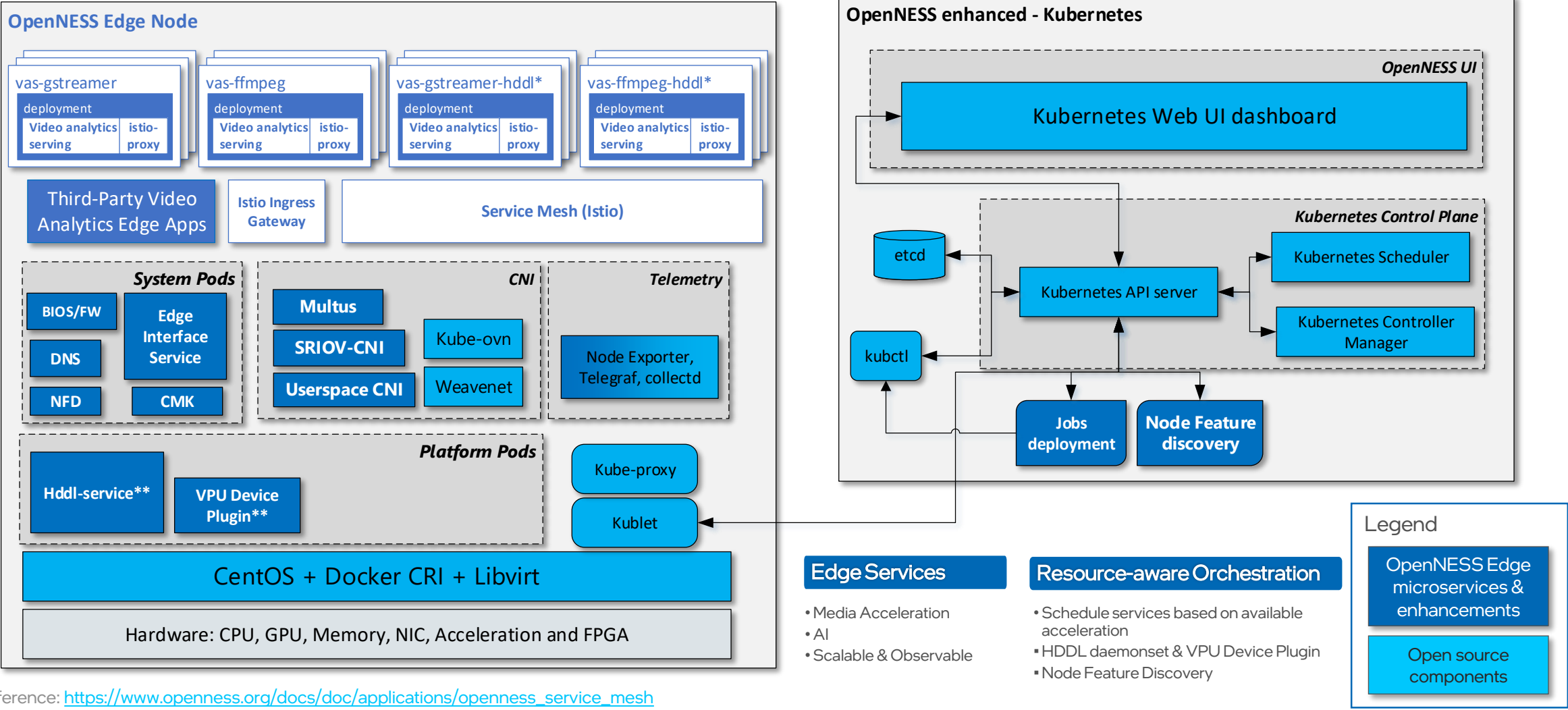
- SRIOV NIC, OPAE & SRIOV FEC operators are deployed for Intel® FPGA PAC device
- Introduces an extended control loop to deploy device plugin & monitor the FPGA device resources
- User-defined config CRD instructs the control loop to configure the SRIOV virtual functions (VFs) with the FEC encode/decode queues and the encoding technology (LTE Turbo or 5G LDPC) and allocate to vRAN (FlexRAN) pods
- FPGA firmware image upgrades are autonomously executed through OPAE operator to the FPGA devices installed in remote sites
- In-field configuration/programming capabilities are currently not available in off-the-shelf k8s

Alternative Solutions:

- Physically program/config the FPGA (truck roll)
- Implement custom/proprietary solutions

Enables automated remote programing/configuration of the FPGA and resource allocation to it

Open Visual Cloud – Video Analytics Service Mesh

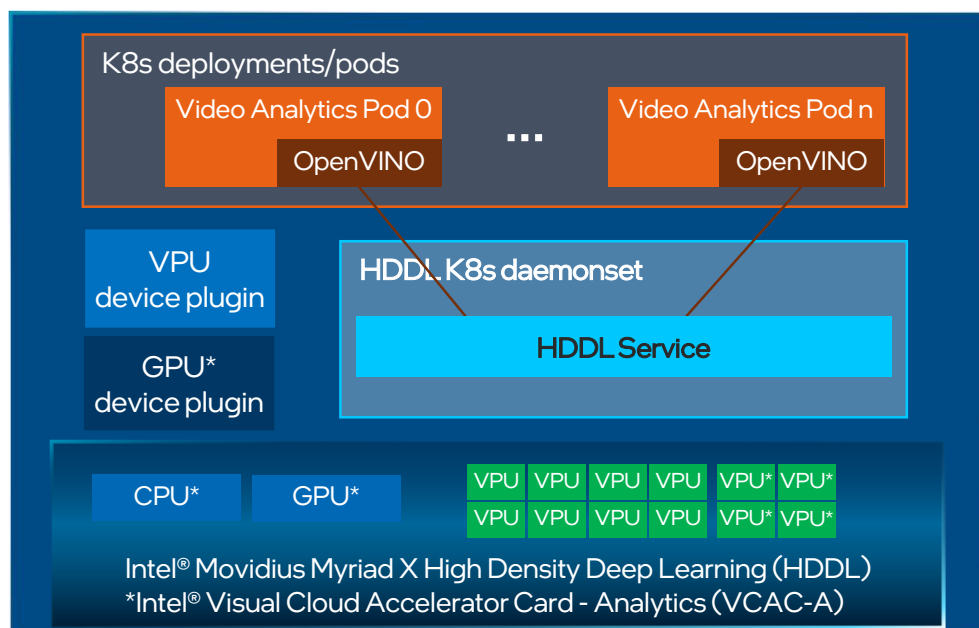
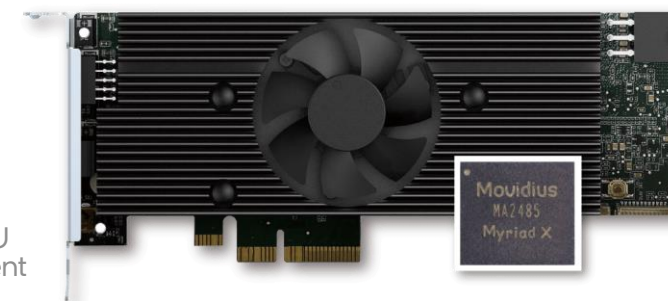
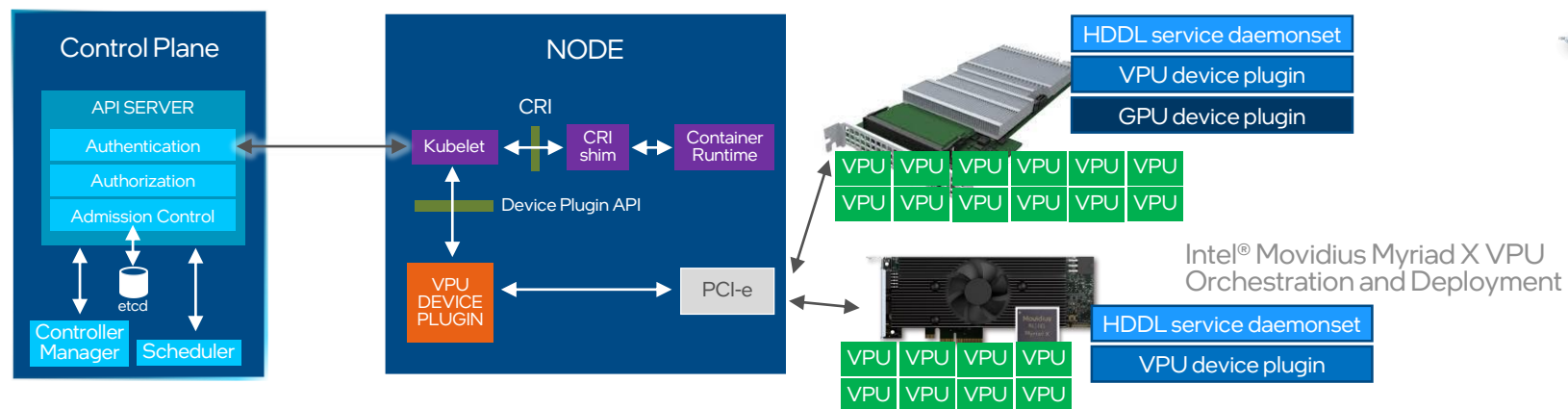


Reference: https://www.openness.org/docs/doc/applications/openness_service_mesh

*In-planning

**Provisioned when Intel® Movidius Myriad X High Density Deep Learning (HDDL) acceleration is available in the cluster

Accelerators – Media Analytics & Transcoding



Intel® OpenVINO based seamlessly consume VPU resources through HDDL service daemonset

What does it do?

- Intel® OpenVINO based applications & services are accelerated using Intel® Movidius Myriad X VPU engines
- VPU device plugin & HDDL service is deployed as daemonset on all edge nodes that has HDDL cards installed
- GPU device plugin is deployed on edge nodes with VCAC-A cards for enhanced media transcoding using the on-board Iris® Pro Graphics GPU

Getting Started



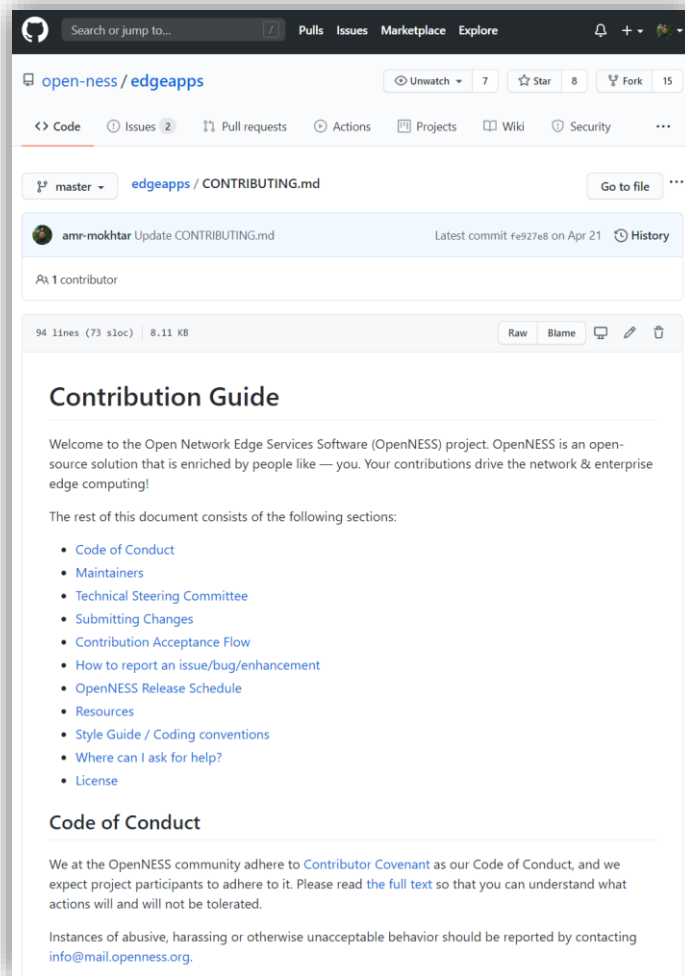
Have an edge application idea?

App vendor
participate in
Intel® Network
Builders

App vendor
contribute app
or C/VNF
through GitHub

OpenNESS
maintainers
review and
accept

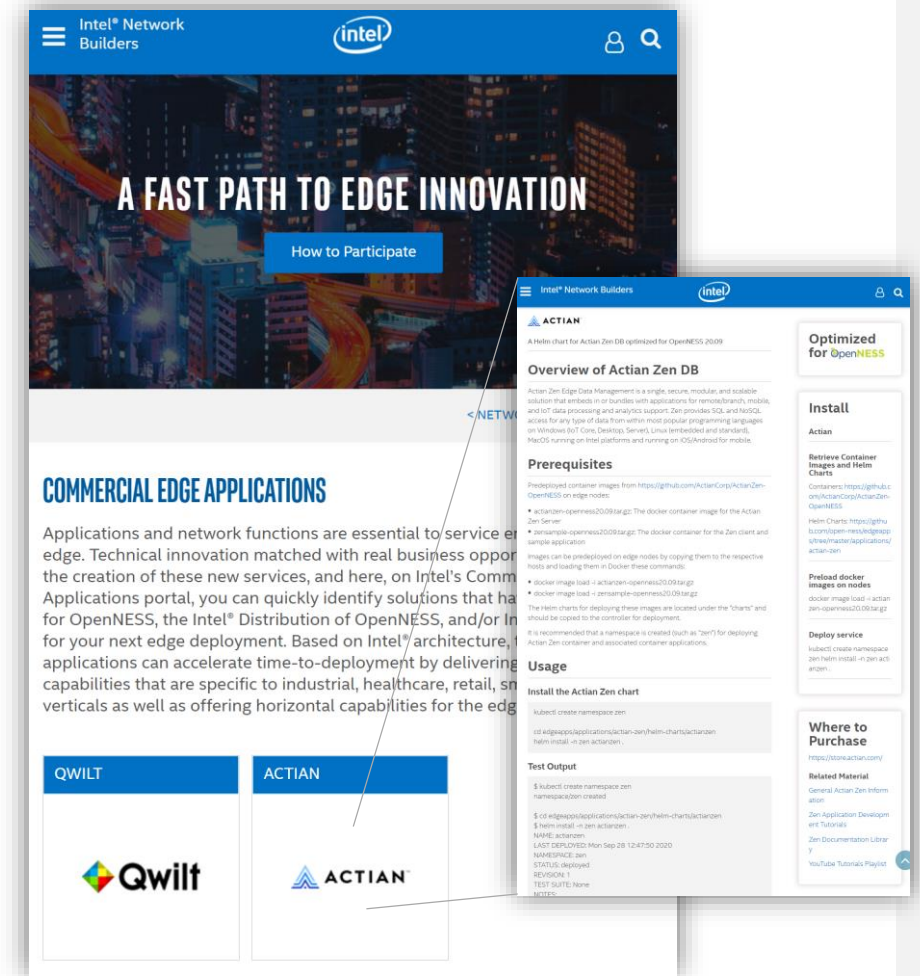
Partner is added
to the portal logo
wall



App Contribution



Enrolment Form



Edge Applications Hub

<https://networkbuilders.intel.com/commercial-applications/participate>

Get in touch



www.openness.org



github.com/open-ness



developer@mail.openness.org



Edge
Applications

github.com/open-ness/edgeapps

networkbuilders.intel.com/commercial-applications



Summary

OpenNESS is an edge computing software toolkit that enables **highly optimized, secure and performant edge platforms** to on-board and manage applications and network functions with **cloud-like agility across any type of network**





OPENNESS
ACCELERATING SERVICE
INNOVATION AT THE EDGE

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Up to 2.5x Accelerated AI Performance: Workload: images per second using AIXPRT Community Preview 2 with Int8 precision on ResNet-50 and SSD-Mobilenet-v1 models. Intel preproduction system, ICL-U, PL1 15w, 4C/8T, Turbo TBD, Intel Gen11 Graphics, GFX driver preproduction, Memory 8GB LPDDR4X-3733, Storage Intel SSD Pro 760P 256GB, OS Microsoft Windows 10, RS5 Build 475, preprod bios. Vs. Config – HP spectre x360 13t 13-ap0038nr, Intel® Core™ i7-8565U, PL1 20w, 4C/8T, Turbo up to 4.6Ghz, Intel UHD Graphics 620, Gfx driver 26.20.100.6709, Memory 16GB DDR4-2400, Storage Intel SSD 760p 512GB, OS – Microsoft Windows 10 RS5 Build 475 Bios F.26.

Approximately 2x Graphics Improvements: Workload: 3DMark11 v 1.0.132. Intel PreProduction ICL U4+2 15W Configuration (Assumptions); Processor: Intel® Core™ i7 (ICL-U 4+2) PL1=15W TDP, 4C8T, Memory: 2x8GB LPDDR4-3733 2Rx8, Storage: Intel® 760p m.2 PCIe NVMe SSD with AHCI Microsoft driver, Display Resolution: 3840x2160 eDP Panel 12.5", OS: Windows* 10 RS5-17763.316, Graphics driver: PROD-H-RELEASES_ICL-PV-2019-04-09-1006832. Vs config – Intel PreProduction WHL U4+2 15W Configuration (Measured), Processor: Intel® Core™ i7-8565U (WHL-U4+2) PL1=15W TDP, 4C8T, Turbo up to 4.6Ghz, Memory: 2x8GB DDR4-2400 2Rx8, Storage: Intel® 760p m.2 PCIe NVMe SSD with AHCI Microsoft driver, Display Resolution: 3840x2160 eDP Panel 12.5", OS: Windows* 10 RS4-17134.112., Graphics driver: 100.6195

Nearly 3x Faster Ultra-High-Speed Wireless Connectivity: 802.11ax 2x2 160MHz enables 2402Mbps maximum theoretical data rates, ~3X (2.8X) faster than standard 802.11ac 2x2 80MHz (867Mbps) as documented in IEEE 802.11 wireless standard specifications and require the use of similarly configured 802.11ax wireless network routers.

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